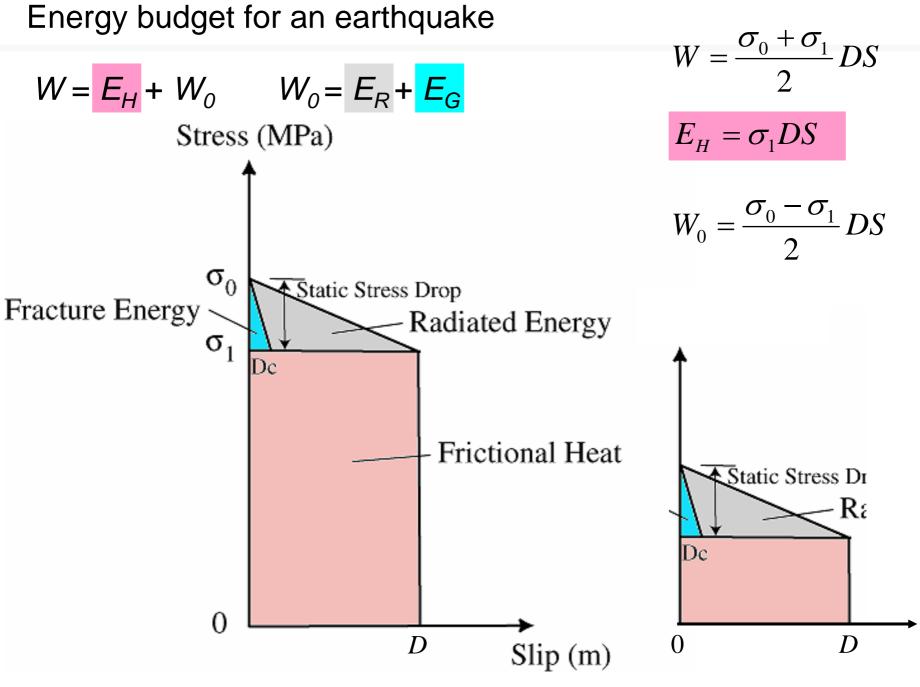
Heat Signature on the Chelungpu Fault Associated with the 1999 Chi-Chi, Taiwan Earthquake

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Goal of the talk

Target: Temperature (heat) signature of the earthquake

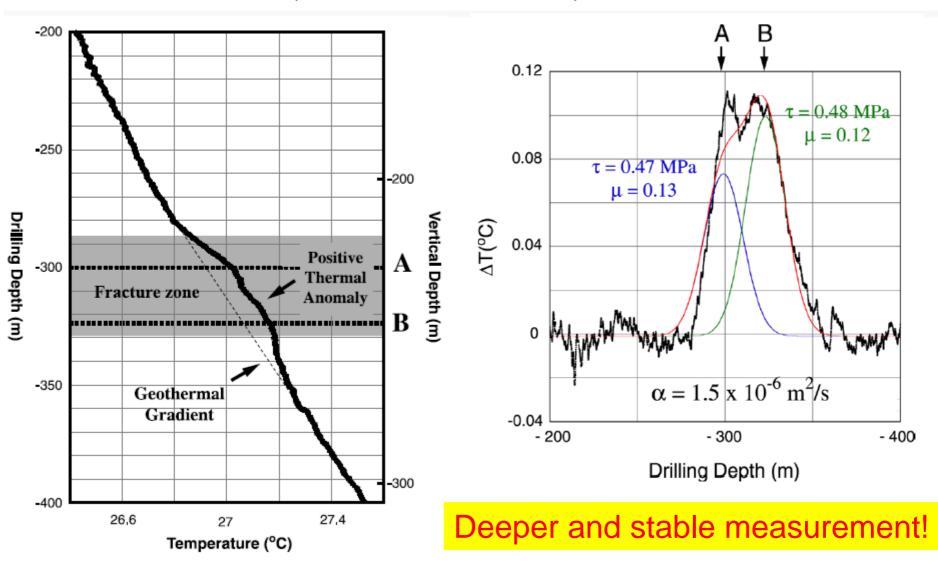
We observed temperature signature around the fault zone along the Chelungpu fault (September, 2005) The signature can be interpreted as the frictional heat caused by fault slip at the time of the 1999 Chi-Chi earthquake

Evaluate other cause of the temperature anomaly(1) Spatial variation of material thermal conductivityEstimate "noise level" and obtain upper bound of heat strength

(2) Water flow

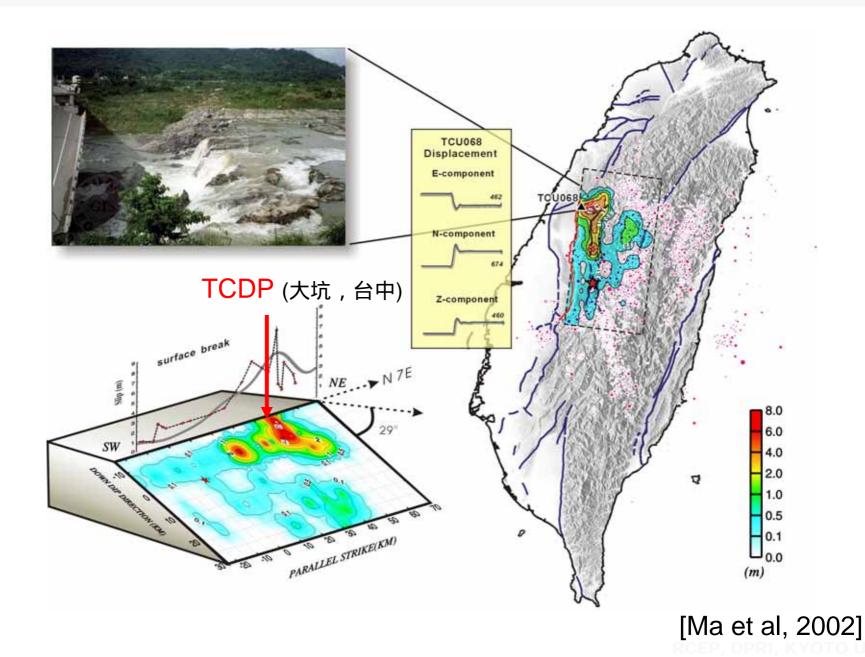
Calculate the temperature anomaly affected by 1-dimensional water flow

Shallow borehole (Tanaka et al., 2006)

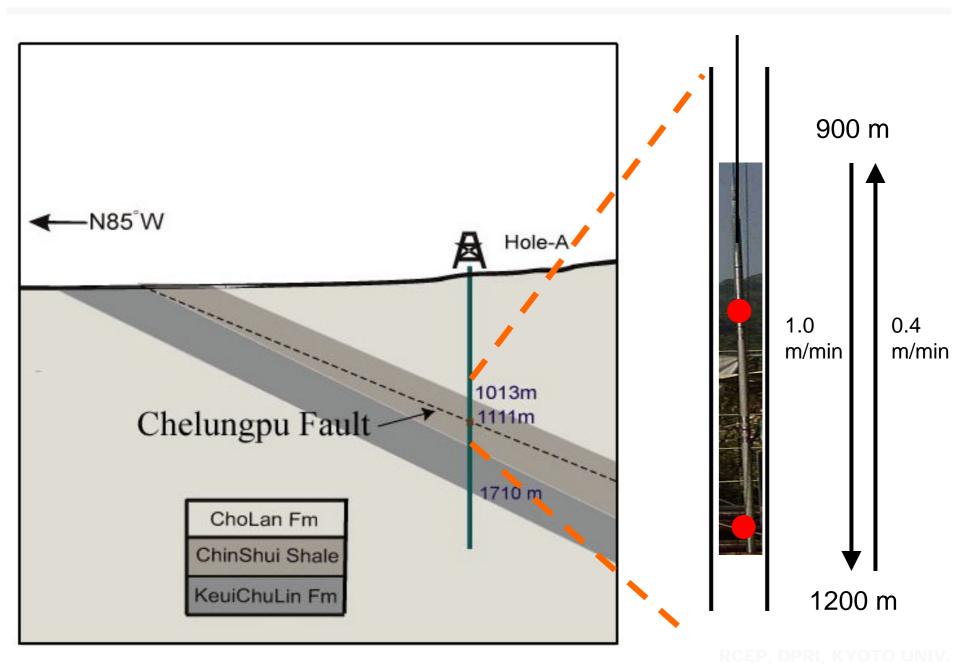


Relatively broad anomaly: affected by shallow ground water flow? Mesurement right after drilling: drilling effect

1999 Chi-Chi earthquake and TCDP site



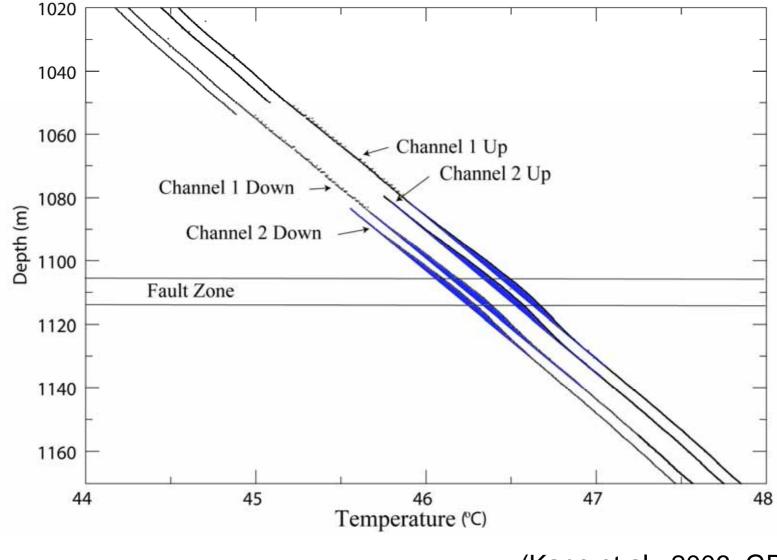
Measurement



Quartz thermometer



Temperature profile using Quartz thermometer



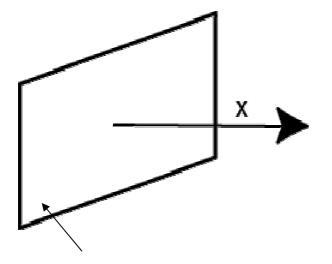
(Kano et al., 2006, GRL)

Spatio-temporal variation of the temperature signature

One-dimensional heat conduction

$$T(x,t) = \frac{S}{2\sqrt{\pi\alpha t}} \exp\left(-\frac{x^2}{4\alpha t}\right)$$

(Officer, 1974)

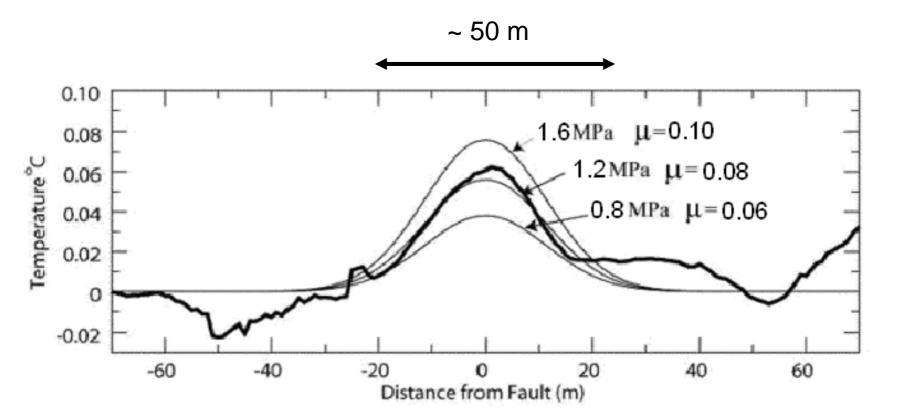


Plane Heat Source = S

S: strength of source, °Cm : thermal diffusivity,

> Temperature anomaly Transient: Friction, Stable: Geothermal gradient + thermal property

Temperature anomaly



Remove linear temperature gradient Average of 4 profiles

4 m slip, 6 years, = $3.4 \times 10^{-7} \text{ m}^2/\text{s}$

(Kano et al., 2006, GRL)

Heat diffusivity $\sim 0.3 \times 10^{-6} \text{ m}^2/\text{s}$ $(k \sim 0.9 \text{ Wm}^{-1}\text{K}^{-1})$ Strength of source $S \sim 1 \text{ }^{\circ}\text{Cm}$ $(Q \sim 4 \times 10^6 \text{ J/m}^2)$ Shear stress $\sim 0.6 \text{ MPa}$

Frictional coefficient $\mu \sim 0.04$

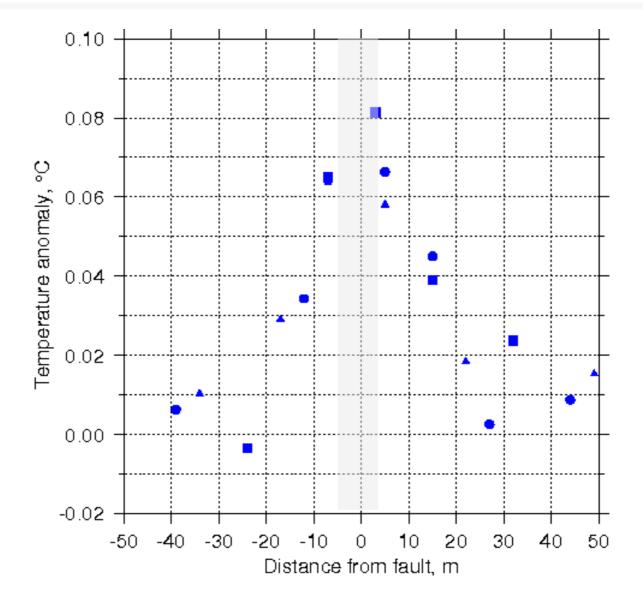
Upper limit of shear stress ~ 1.7 MPa

Frictional coefficient $\mu \sim 0.1$

Pt-RTD thermometer



Temperature anomaly using another thermometer (Pt-RTD)



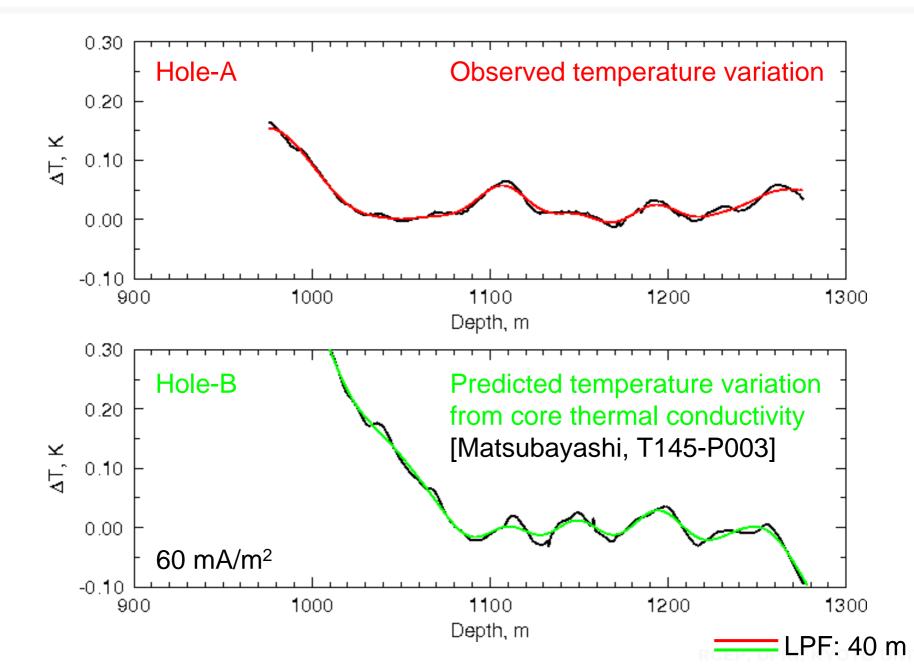
Shear stress and frictional heat

$$q = \kappa \frac{dT}{dz}$$

- q : Heat flow
 - : Thermal conductivity
- T : Temperature
- z : depth

Temperature gradient (-> temperature structure) is affected by variation of thermal conductivity under constant heat flow.

Temperature observation and core measurement



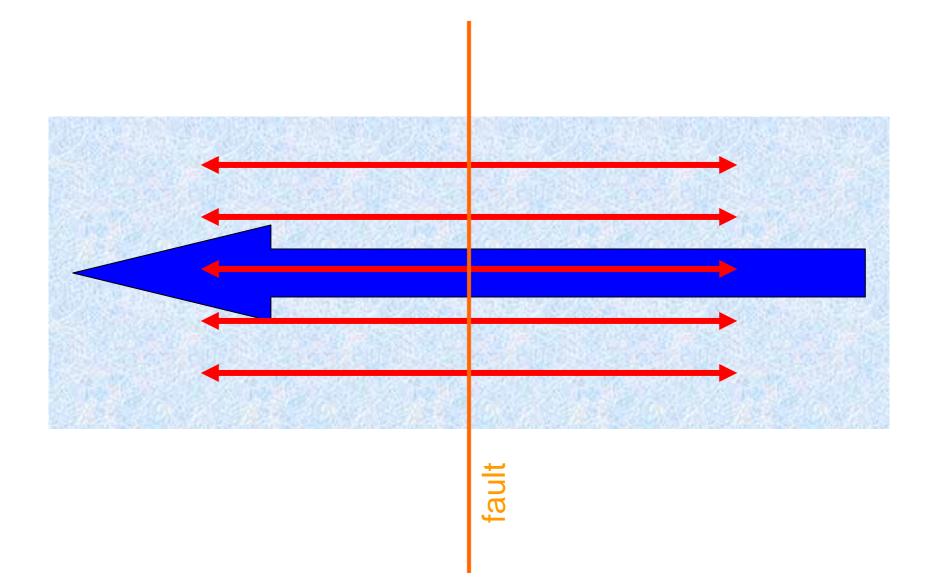
Effect of water flow

$$\alpha \frac{\partial^2 T}{\partial x^2} - \frac{n \rho_w c_w}{\rho c} v \frac{\partial T}{\partial x} = \frac{\partial T}{\partial t}$$

(Domenico and Schwartz, 1997)

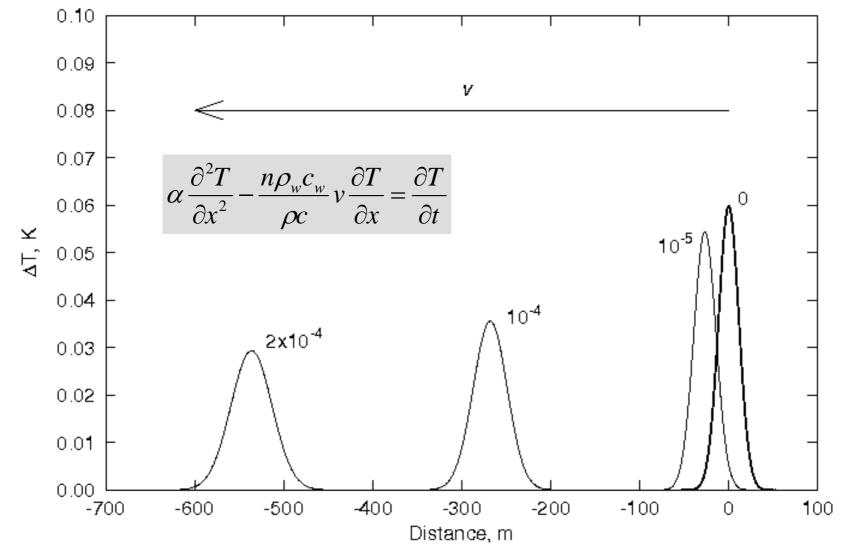
- *v* : flow rate
- *n* : porosity
 - w: density of water
- c_w : specific heat of water.

Effect of water flow



Effect of waster flow

(Kano et al., 2006, GRL)

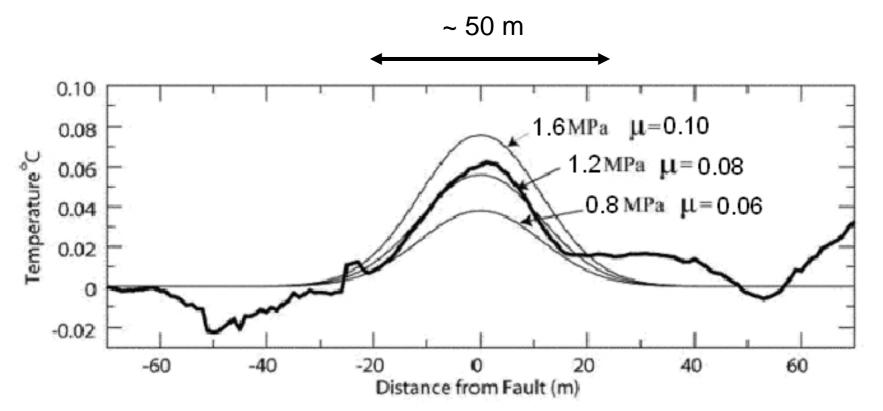


The effect of the water flow: (1) move the anomaly downstream in position (2) broaden its shape

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Temperature anomaly

(Kano et al., 2006, GRL)



Remove linear temperature gradient Average of 4 profiles

Observed temperature signature is located right at the location of the fault

Summary

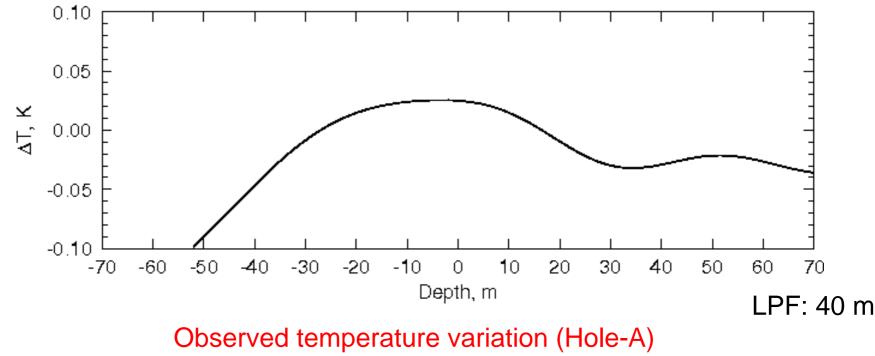
 (1) Spatial variation of material thermal conductivity may cause noise in data
 Our observation gives upper bound of heat strength (still low friction)

(2) Minimal effects from fluid flow in our observed temperature signature

(3) Small heat signature indicates a low level friction on the fault during earthquake Shear stress: 2 MPa

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Temperature observation and core measurement



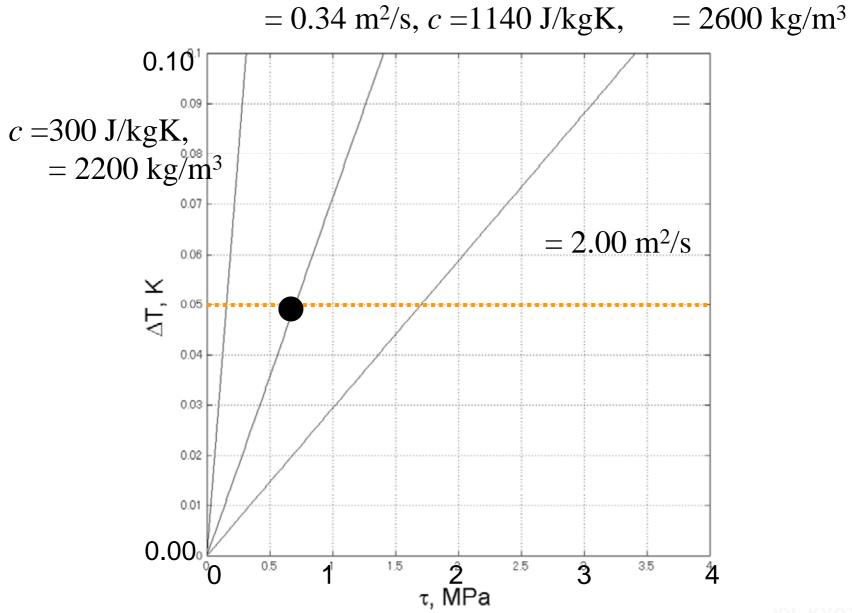
Predicted temperature variation (Hole-B)

Correct background temperature gradient

- Depth correction (Hole-A vs Hole-B)
- Appropriate filter

Our estimate give upper bound of temperature anomaly

Upper limit of the shear stress



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Motivation

Find the temperature signature associated with the 1999 Chi-Chi, Taiwan earthquake

Amount of frictional heat (~ Level of shear stress)

Key unknown values of important parameter for understanding the physics of earthquake rupture

Cannot be determined by seismic observation

Residual heat

Can be observed as temperature anomaly along the fault

Precise temperature measurements

Development of thermometers Quartz thermometer (0.003 ° C) Pt-RTD thermometer (0.001 ° C)

No water flow in the borehole Cased borehole

No drilling disturbance

A half year from the end of drilling

Quartz thermometer



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Pt-RTD thermometer



Estimation

Assumption

- Transferred to frictional heat
- One-dimensional heat conduction
- Constant background thermal gradient

$$\Delta T(x,t) = \frac{\Delta S}{2\sqrt{\pi\alpha t}} \exp\left(-\frac{x^2}{4\alpha t}\right)$$

$$\tau = S \frac{c \cdot \rho}{u}$$

$$\mu = \frac{\tau}{\sigma_n - p}$$
, inormal stress
(Sibson, 1974)
p : pore pressure
hydrostatic

Summary

Precise temperature measurement reveals

Temperature anomaly of ~ 0.05 $^{\circ}$ C Temperature distribution at depth comparable to core measurement

Low shear stress

Low dynamic friction

Mechanism such as super-hydrostatic pore pressure or lubrication

Future works

Temperature anomaly caused by spatial variation of thermal property Sensor calibration (transfer function of instruments) Repeated measurement (Hole-B ?)

Shear stress and frictional heat

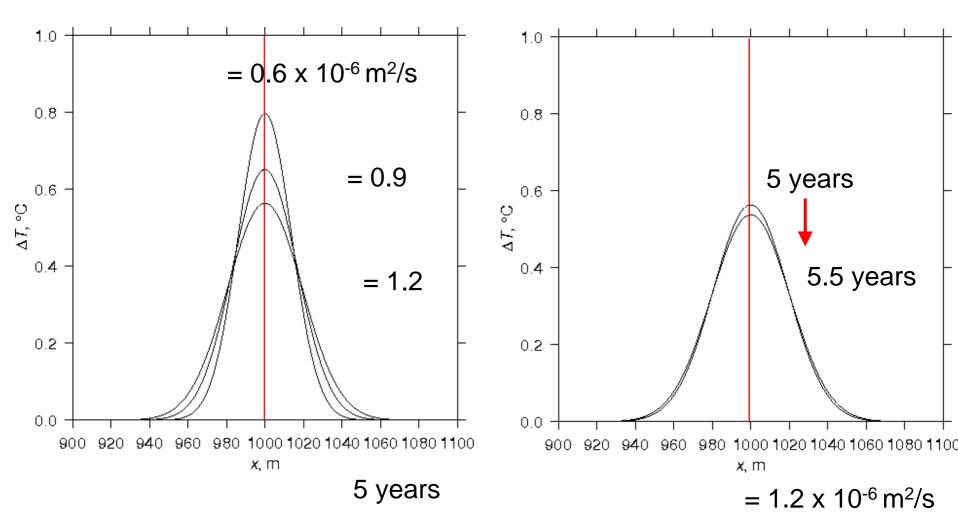
$$S = \frac{\tau \cdot u}{c \cdot \rho}$$

- : Shear stress, MPa
- u: Slip, m
- c: Heat capacity, 1140 J Kg⁻¹ °C⁻¹
 - : Density, 2600 Kg/m³

$$E_H = \sigma_1 DS$$

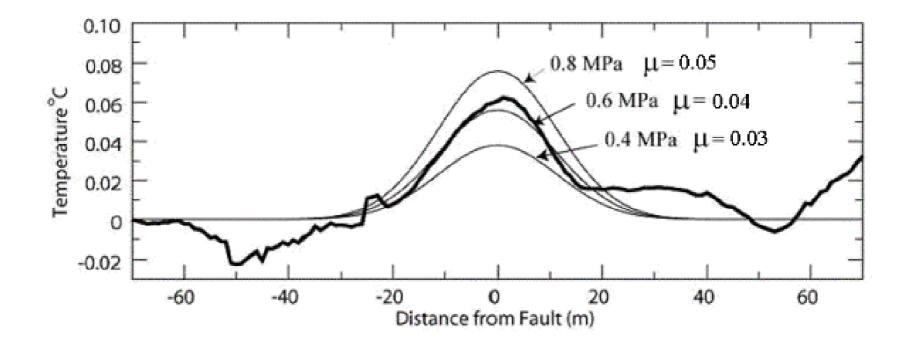
Expectation

Depth 1 km, Slip 8 m, frictional coefficient 0.6 (S ~50 ° Cm)



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Temperature anomaly



Remove linear temperature gradient Average of 4 profiles